



Low Profile and High Efficiency 915 MHz ISM Band Loop Antenna Part No: ILA.01

Description:

915 MHz ISM Band Loop Antenna

Features:

Small size antenna, low profile, and high efficiency 915 MHz ISM Band Dimensions: 10 x 3.2 x 0.5 mm SMT Compatible BoHS & REACH Compliant

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The ILA.01 is a 915 MHz ISM band antenna with excellent efficiency, 60% at the center frequency and 45% at the band edges. This antenna works the best when placed at the center of the board edge. The antenna, at 10 x 3.2 x 0.5 mm, is low profile and would be suitable for devices with space constraints. The ILA.01 is delivered on tape and reel and now allows M2M customers to use an omni-directional SMT antenna. The omni-directional radiation characteristics allow for excellent performance regardless of device orientation. This is especially useful for devices that are not fixed in one particular spot during use. When there is little PCB space available for antenna placement, but high performance is required, the ILA.01 is the ideal choice.

This antenna can be mounted with no performance degradation in either orientation as long as the antenna is soldered correctly via Surface mounting. Please see the integration instructions section for further detail regarding the optimum way to integrate this antenna into your device."

For further optimization to customer-specific device environments and for support to integrate and test this antennas performance in your device, contact your regional Taoglas Customer Services Team.

Applications:

Automated Meter Reading (AMR) Radio Frequency Identification (RFID) **Remote Monitoring** Healthcare Sensing 915 MHz Applications

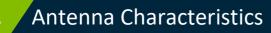


Specifications

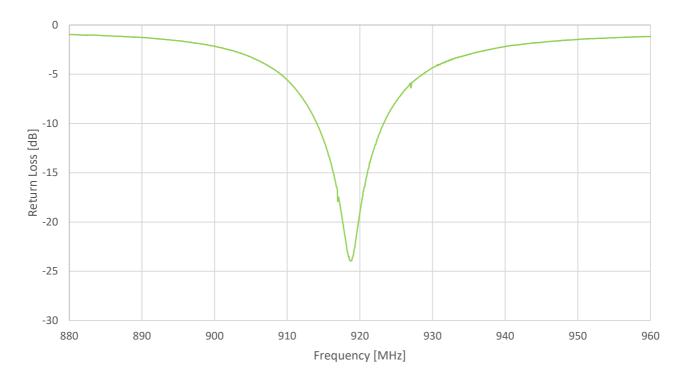
2.

Antenna				
Frequency (MHz)	902-928 MHz (ISM)			
	Efficiency (%)			
80 x 40 mm Ground Plane	50 (typical)			
	Average Gain (dB)			
80 x 40 mm Ground Plane	-5 dB			
	Peak Gain (dBi)			
80 x 40 mm Ground Plane	1.5 dBi			
Max Return Loss (dB)	-2.8 dB			
VSWR	6:1			
Impedance (Ω)	50Ω			
Polarization	Linear			
Radiation Pattern	Omni			
Input Power(W)	5			
	Mechanical			
Dimensions (mm)	10 x 3.2 x 0.5			
Required Space (mm)	11 x 10.4			
Material	Ceramic			
EVB Connector	SMA(F)			
Environmental				
Temperature Range	-40°C to 85°C			
Storage Temperature	-40°C to 105°C			
Humidity	40% to 95%			
Moisture Sensitivity Level	3 (168 Hours)			

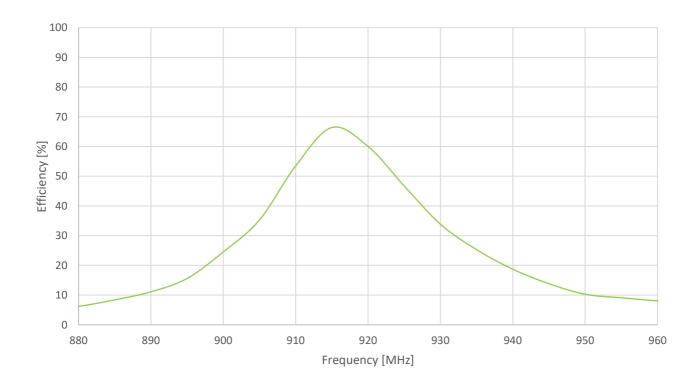






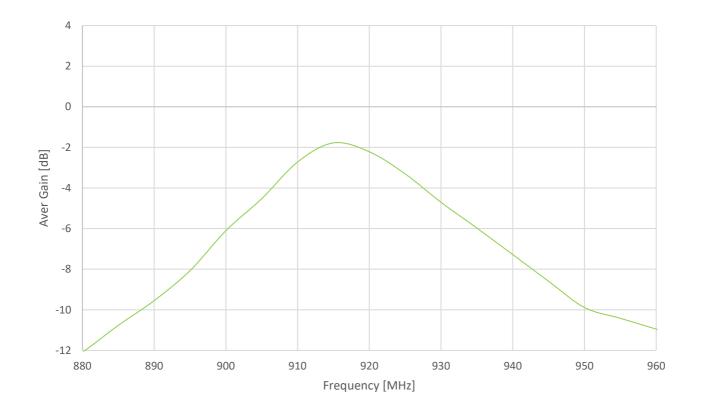




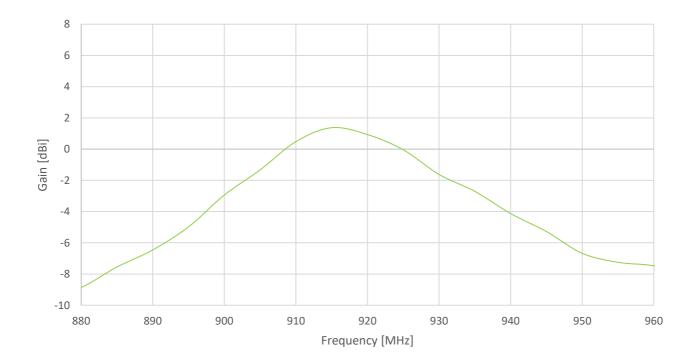




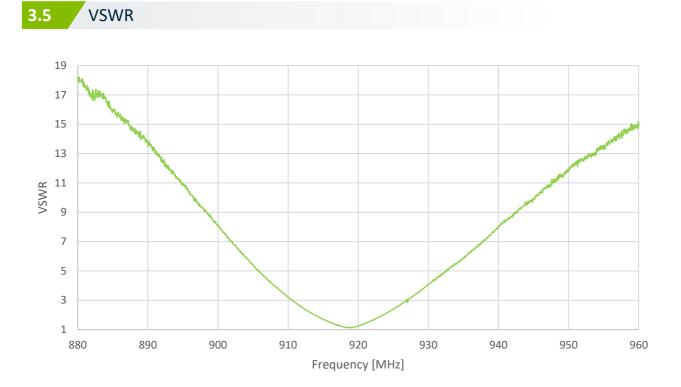
3.3 Average Gain









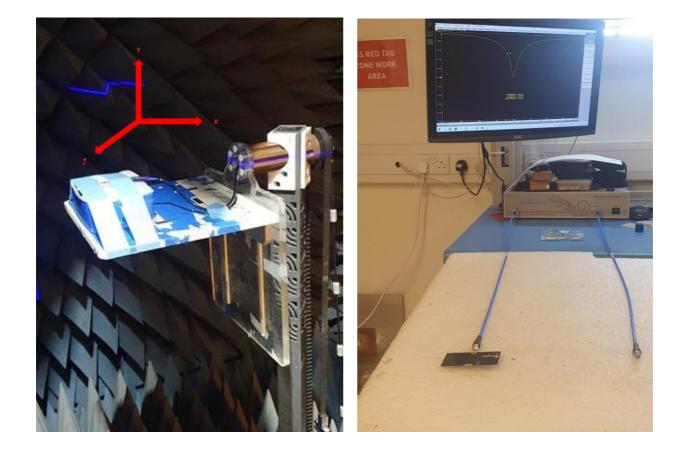






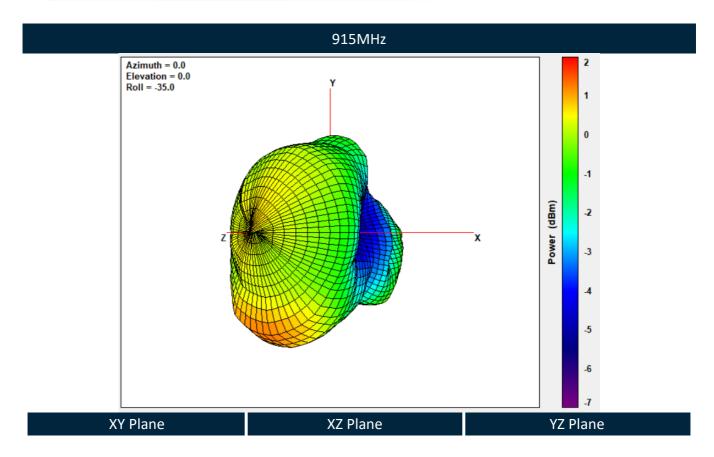
4. Radiation Patterns

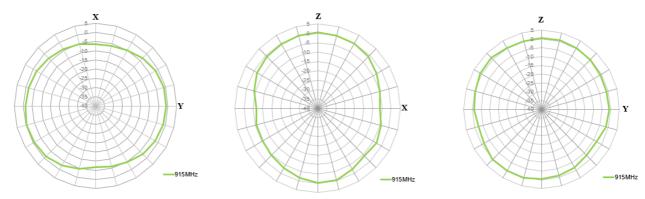
4.1 Test Setup – Antenna on Evaluation Board







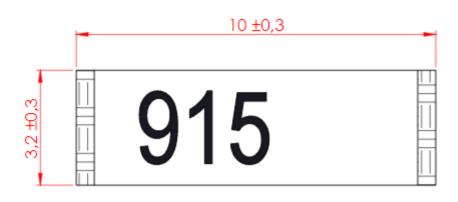


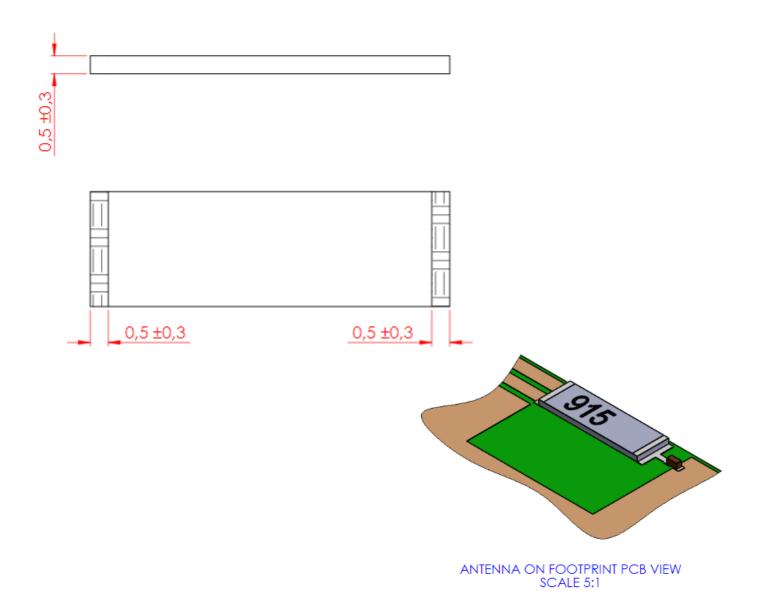


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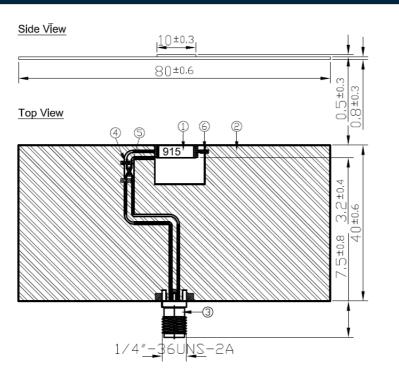
5.

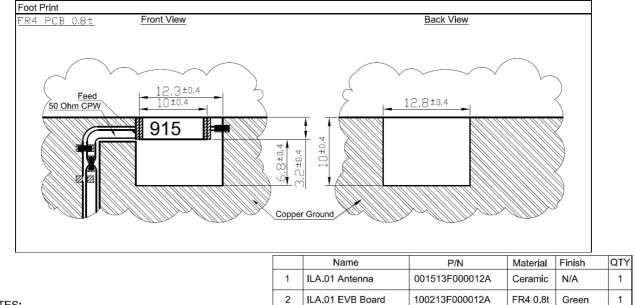






Mechanical Drawing – Evaluation Board 6.





NOTES:

- 1. Solder Area 2. Logo & Text Ink Printing : Black 3. Copper 4. Matching Component

- 5. Component 6 is the tuning element of this antenna.

1	ILA.01 Antenna	001513F000012A	Ceramic	N/A	1
2	ILA.01 EVB Board	100213F000012A	FR4 0.8t	Green	1
3	SMA(F) ST	200413F000012A	Brass	Gold	1
4	Capacitor 4.3pF (0402)	001514F020012A	Ceramic	N/A	1
5	Resistor 0Ω (0402)	001511J010012A	Ceramic	N/A	1
6	Capacitor 10pF (0402)	001514F010012A	Ceramic	N/A	1



7. Antenna Intergration Guide



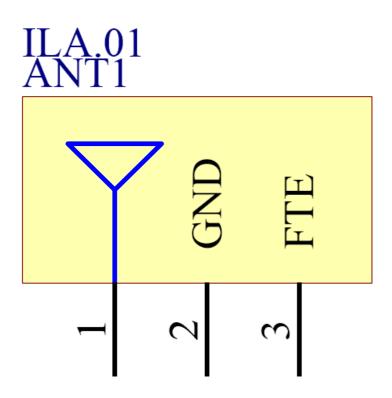




7.1 Schematic Symbol and Pin Definition

The circuit symbol for the antenna is shown below. The antenna has 3 pins with only three pins as functional.

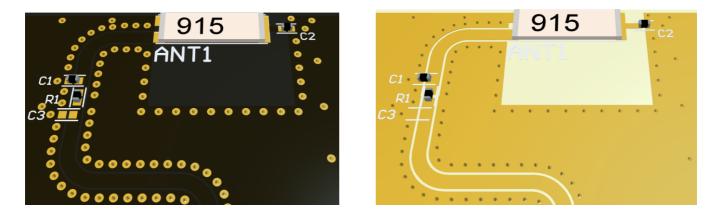
Pin	Description
1	RF Feed
2	Ground
3	FTE





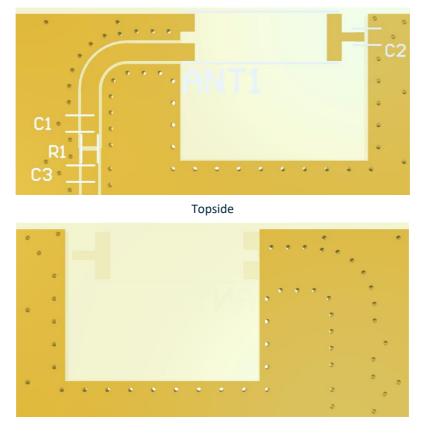
7.2 Antenna Integration

Whatever the size of the PCB, the antenna should ideally be placed on the PCB's longest side, to take advantage of the ground plane. Optimized matching components can be placed as shown.



7.3 PCB Layout

The footprint and clearance on the PCB must meet the antenna specification. An example of the PCB layout shows the antenna footprint with clearance. Note the placement of the component C2. C2 is connected to Pin 3 of the antenna and helps with fine-tuning of the antenna. Further, note the placement of the additional components C1, R1, C3. These form a pi-matching network to help with matching the antenna in its final environment.

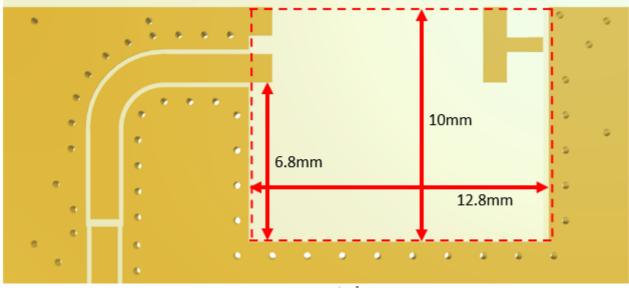


Bottom Side

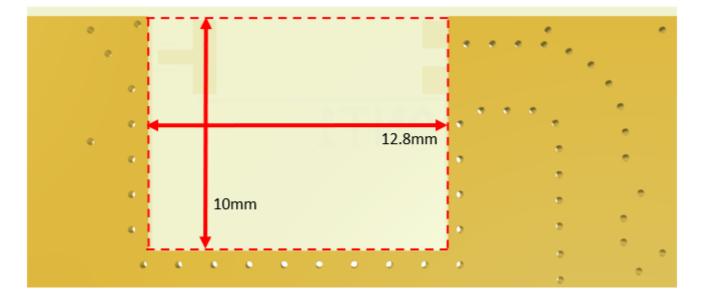


7.4 PCB Keep Out

Below shows the antenna footprint and clearance through ALL layers on the PCB. Only the antenna pads and connections to feed and GND are present within this clearance area (marked RED). The clearance area extends to 10mm in length & 12.8mm in width. This clearance area includes the bottom side and ALL internal layers on the PCB.



Topside



Bottom Side

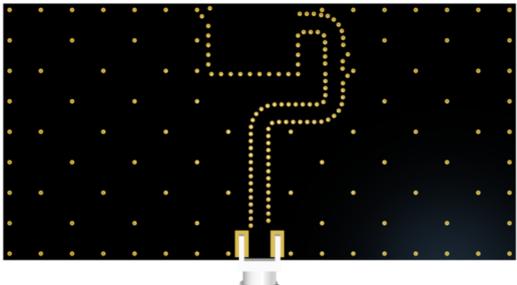


7.5 Evaluation Board





Topside

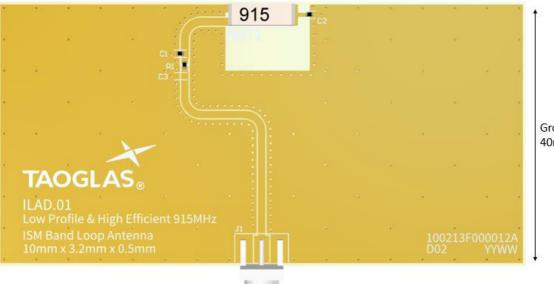




Bottom Side



7.6 Evaluation Board Ground Plane Length

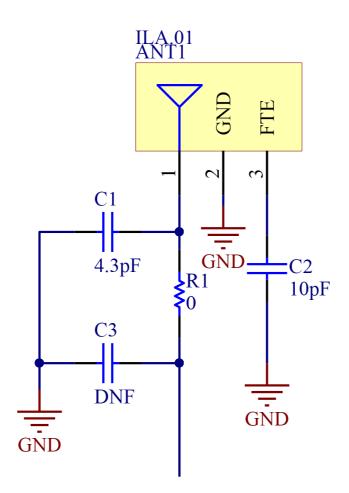


Ground Plane Length 40mm



7.7 Evaluation Board Matching Circuit

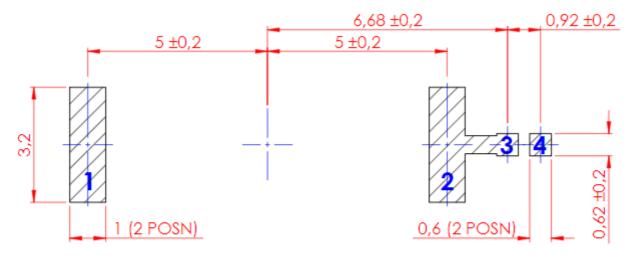
Matching components for the ILA.01 are required for the antenna to have optimal performance on the evaluation board, located outside of the copper clearance in the space specified in the above images. Additional matching components may be necessary for your device, so we recommend incorporating extra component footprints, forming a "pi" network, between the radio module and the antenna.



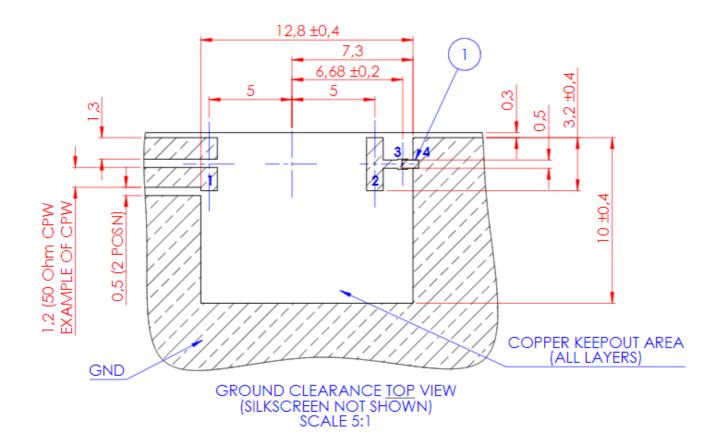
Designator	Туре	Value	Manufacturer	Manufacturer Part Number
R1	Resistor	0 Ohms	Yageo	RC0402JR-070RL
C1	Capacitor	4.3pF	Murata	GRM1555C1H4R3CA01D
C2	Capacitor	10pF	Murata	GRM1555C1H100RA01D
C3	Capacitor	Not Fitted	-	-







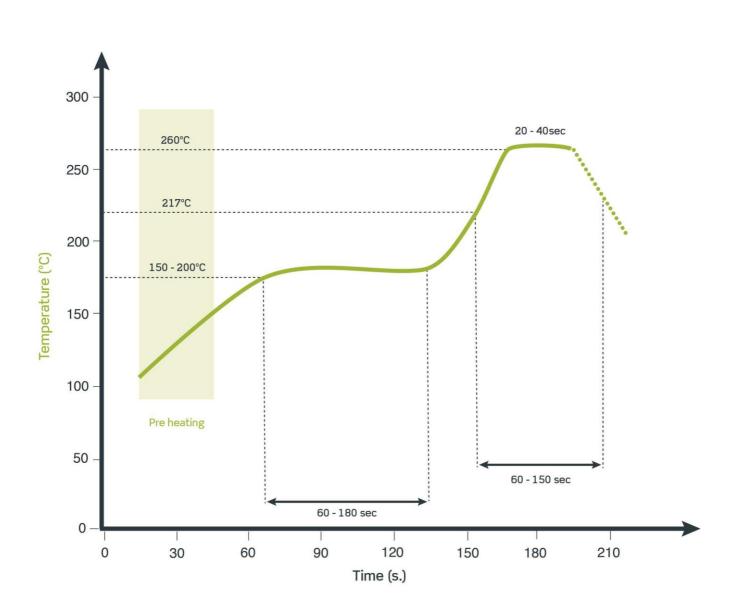
FOOTPRINT PCB





Recommended Solder Reflow Profile

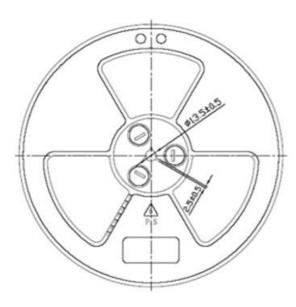
Typical Soldering profile for lead-free process:

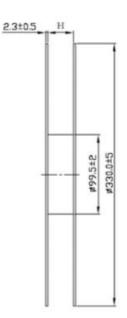


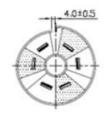


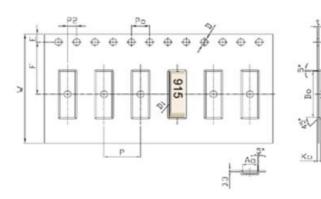
9. Packaging

6000pcs ILA.001 per reel Dimensions – 420*380mm Weight – 1050g









Tape Dimensions(unit: mm)

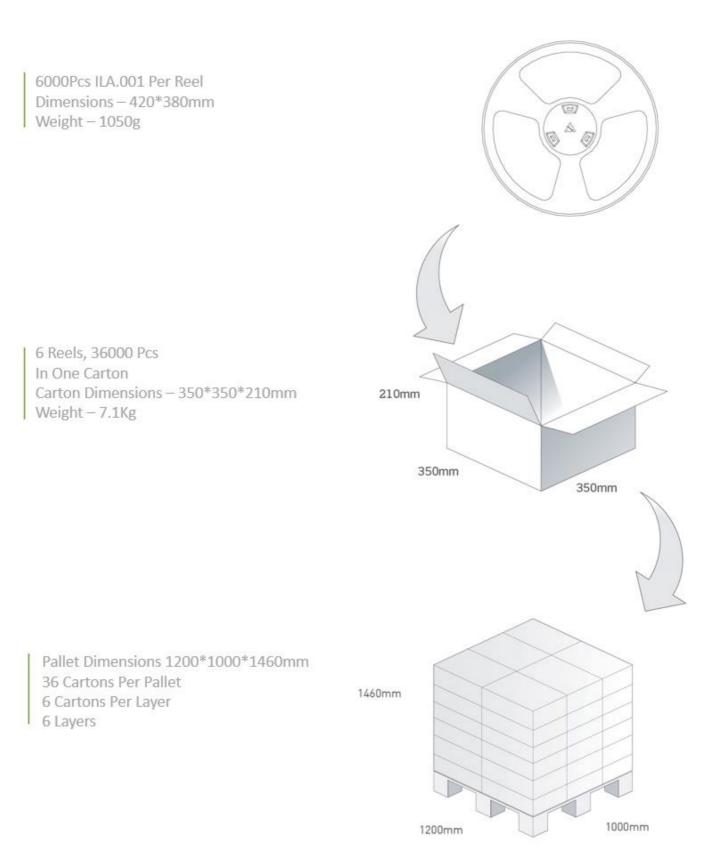
Feature	Specifications	Tolerances
W	24.00	±0.30
P	8.00	±0.10
E	1.75	±0.10
F	11.50	±0.10
P2	2.00	±0.10
D	1.50	+0.10 0.00
D1	1.50	±0.10
Po	4.00	±0.10
10Po	40.00	±0.20

Pocket Dimensions(unit: mm)

Feature	Specifications	Tolerances
Ao	3.40	±0.10
Bo	10.20	±0.10
Ko	0.70	±0.10
t	0.30	±0.05

SPE-12-8-079-I







SPE-12-8-079 – ILA.01					
	Revision: I				
	Revision: I				
	Date:	2023-01-17			
	Changes:	Updated product image			
	Changes Made by:	Cesar Sousa			

Previous Revisions

Revision: H (Current Version)		
Date:	2022-06-23	
Changes:	Updated antenna integration guide, radiation patterns and graphs	
Changes Made by:	Evan Murphy	

Revision: C		
Date:	2014-08-19	
Changes:	EVB & Footprint	
Changes Made by:	Aine Doyle	

Revision: G (Current Version)		
Date:	2021-10-28	
Changes:	Format Change, MSL	
Changes Made by:	Erik Landi	

Revision: B		
Date:	2012-06-27	
Changes:		
Changes Made by:	Technical Writer	

Revision: F	
Date:	2017-10-23
Changes:	Packing drawing updated
Changes Made by:	Carol Faughnan

Revision: A (Original First Release)	
Date:	2012-05-08
Notes:	Initial Release
Author:	Technical Writer

Revision: E		
Date:	2017-04-21	
Changes:		
Changes Made by:	Technical Writer	

Revision: D		
Date:	2016-09-12	
Changes:		
Changes Made by:	Technical Writer	



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